

MBXS SERIES

MINIATURE SINGLE-PHASE SURFACE MOUNT BRIDGE RECTIFIER

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MB05S THRU MB10S



MINIATURE GLASS PASSIVATED SINGLE-PHASE SURFACE MOUNT BRIDGE RECTIFIER

REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 0.5 AMPERE

FEATURES

· Glass passivated chip junction

· Low forward voltage drop

· High surge overload rating of 30 Amperes peak

· Ideal for printed circuit board

 \cdot High temperature soldering guaranteed:

260°C for 10 seconds

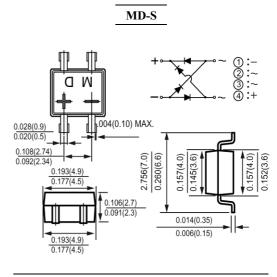
MECHANICAL DATA

Case: Molded plastic, MD-S

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any Weight: 0.008ounce, 0.22gram



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	MB05S	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current						•		•	
(see Fig. 1) on glass-epoxy P.C.B (Note 2)	I _(AV)	$\mathbf{I}_{(AV)}$ 0.5							Amp
on aluminum substrate (Note 3)	0.8								
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I_{FSM}	30							Amp
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage	V	1.0							Volts
at 0.4A DC and 25	V_{F}								
Maximum Reverse Current at T _A =25	ī	5.0 500							uAmp
at Rated DC Blocking Voltage T _A =125	I_R								
Typical Junction Capacitance (Note 1)	C _J				13				pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$				70				/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$				20				/W
Operating and Storage Temperature Range	T _J , Tstg				-55 to +15	0			

NOTES:

- 1- Measured at 1 $\mbox{MH}_{\mbox{\scriptsize Z}}$ and applied reverse voltage of 4.0 VDC.
- 2- On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads
- 3- On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad



RATINGS AND CHARACTERISTIC CURVES

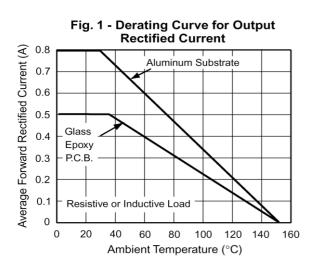


Fig. 2 - Maximum Non-Repetitive Peak **Forward Surge Current Per Leg** 35 Peak Forward Surge Current (A) T_A = 40°C 30 Single Half Sine-Wave (JEDEC Method) 25 f = 60 Hz 20 f = 50 Hz 15 10 5.0 0 10 100 Number of Cycles

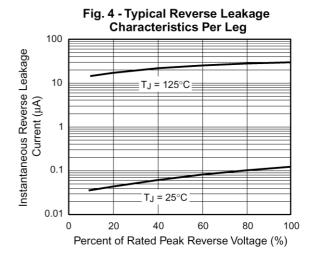


Fig. 5 - Typical Junction Capactitance Per Leg 30 T_J = 25°C 25 Junction Capacitance (pF) f = 1 MHzVsig = 50mVp-p 20 15 10 5.0 0 100 200 0.1 10 Reverse Voltage (V)